# CMOS090 technology DIODEGATE25 models DK\_MIKRON

**SPICE Models Benchmarks** 

**June 2010** 

TR&D / STD / T2D /

**Modeling / CM2A** 

#### **General information on DIODEGATE25 models**

Supply voltage (Vdd) is 2.5 V.

Validity domain is defined as follows:

Device temperature varies from -40 °C to 150 °C.

Vgs, Vds and Vbs vary from 0 V to 2.75 V (i.e. Vdd + 10%).

#### **Conditions of simulation**

Simulations were done with Bench v3.6.3sram using Eldo simulator v6.7\_1.2.

If not explicitly mentioned elsewhere, temperature is set to temp ° C and Vbs to 0 V.



### **Output parameters definition**

In what follows, M, W and L (all default to 1) designate the number of devices in parallel (i.e. multiplication factor), the total drawn gate width and the drawn gate length, respectively.

- **Cj**: Junction diode capacitance at Vr = 0 V, f = 100k Hz.
- Ij: Junction diode leakage current at Vr = 2.5 V.

#### **DGNSVT25**

Electrical characteristics per geometry



June 2010

## dgnsvt25 w=0.4 l=0.3 @ temp=25

	DGNSVT25_CMIN	DGNSVT25_TYP	DGNSVT25_CMAX
Cj [pF]	43.158	40.053	37.339
lj [aA]	3395.7	354.54	36.952

#### **DGPSVT25**

Electrical characteristics per geometry



June 2010

## dgpsvt25 w=0.4 l=0.3 @ temp=25

	DGNSVT25_CMIN	DGNSVT25_TYP	DGNSVT25_CMAX
Cj [pF]	41.499	38.693	36.21
lj [aA]	2867.4	299.16	31.157

June 2010

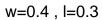
#### **DGNSVT25**

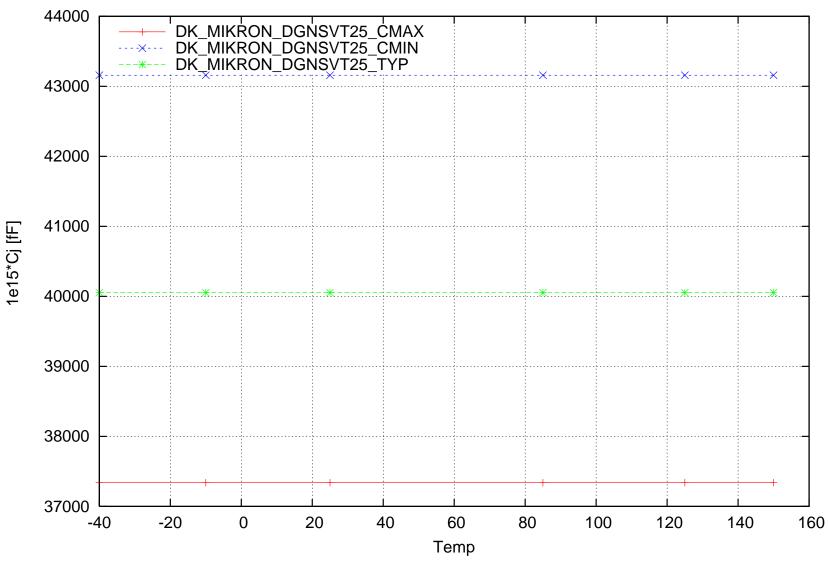
# **Electrical characteristics scaling**



June 2010

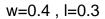
## dgnsvt25 1e15\*Cj [fF] vs. Temp , w=0.4 , l=0.3

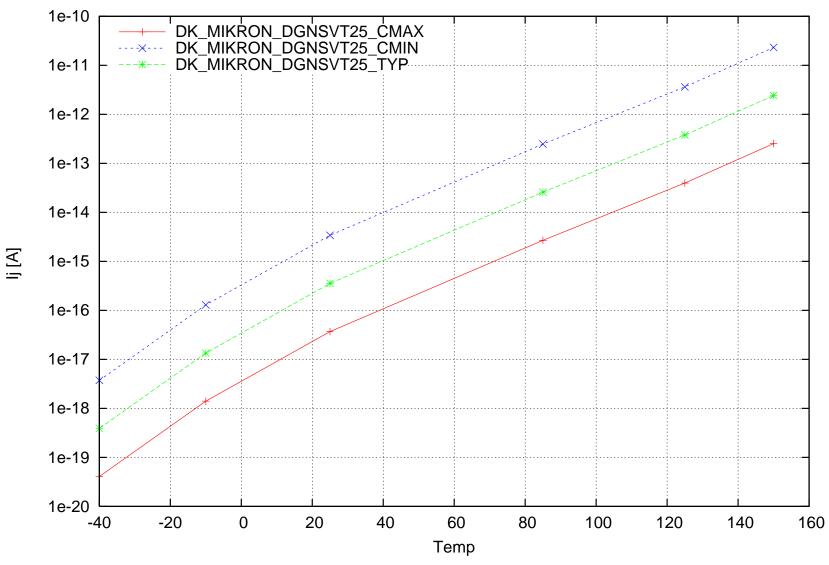




June 2010

## dgnsvt25 lj [A] vs. Temp, w=0.4, l=0.3





June 2010

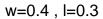
#### **DGPSVT25**

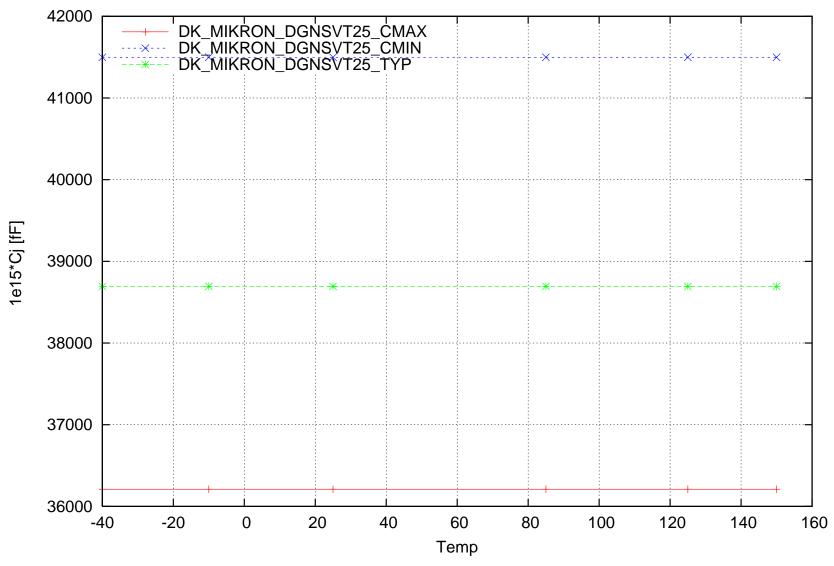
# **Electrical characteristics scaling**



June 2010

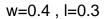
# dgpsvt25 1e15\*Cj [fF] vs. Temp , w=0.4 , l=0.3

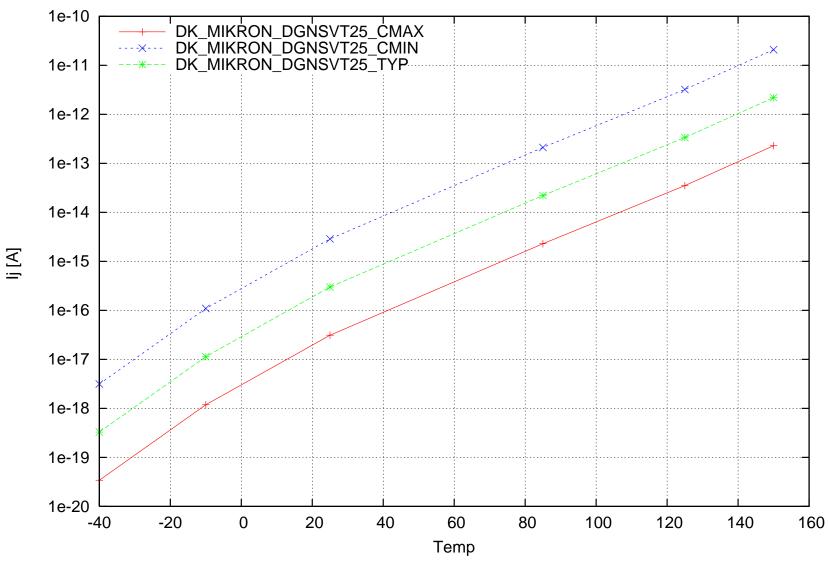




June 2010

## dgpsvt25 lj [A] vs. Temp, w=0.4, l=0.3





June 2010